| ASSOCIATION CONNECTIN                     | Material Composition Declaration<br>© Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both<br>international and Pan-American copyright conventions. |                           |                                  |                     | This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility. |                               |                     |   |            |                                 |                                 |                  |      |           |  |
|---|---|---------------------------|----------------------------------|---------------------|---|-------------------------------|---------------------|---|------------|---------------------------------|---------------------------------|------------------|------|-----------|--|
| 1752-21.1                                 | IPC Web Site for Information on IPC-1752 Standard Form Type<br>http://www.ipc.org/IPC-175x Distribute   |                           |                                  |                     | * Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Materi  |                               |                     |   | ials and N | als and Mfg Information         |                                 |                  |      |           |  |
| Supplier Inform                           | ation   |                           |                                  |                     |   |                               |                     |   |            |                                 |                                 |                  |      |           |  |
| Company name*                             |   |                           | Company unique ID                |                     |   | -                             | Unique ID Authority |   |            |                                 | Response Date*                  |                  |      |           |  |
| onsemi                                    |   |                           |                                  |                     |   |                               |                     |   |            |                                 | 2024-04                         | 2024-04-18       |      |           |  |
| Contact Name                              |   |                           | Title - Contact                  |                     |   |                               | Phone - Contact*    |   |            |                                 | Email -                         | Email - Contact* |      |           |  |
| Product-Env-Stewards                      |   |                           | Product Enviro Compliance        |                     |   |                               | NA                  |   |            |                                 | Product-Env-Stewards@onsemi.com |                  |      |           |  |
| Authorized Represe                        | ntative*  | Title - Representative    |                                  |                     |   | Phone - Representative*       |                     |   |            | Email - Representative*         |                                 |                  |      |           |  |
| Product-Env-Stewa                         | ırds  | Product Enviro Compliance |                                  |                     |   | NA                            |                     |   |            | Product-Env-Stewards@onsemi.com |                                 |                  |      |           |  |
| Requeste                                  | Requester Item Number Mfr Item  |                           | n Number Mfr Item Name           |                     |   |                               | Effective Date      | Effective Date Version Manufacturing Site |            | Manufacturing Site              |                                 | Weight*          | UOM  | Unit Type |  |
|   |   | CPH6354-TL-W PCH          |                                  | PCH 4V DRIVE SERIES |   | 2024-04-18                    |                     | C   | CNG        |                                 | 15.18                           | mg               | Each |           |  |
| Manufacturing                             | Proccess Information  | 1                         |                                  |                     |   |                               |                     |   |            |                                 |                                 |                  |      |           |  |
| Terminal Plating / Grid Array Material Te |   |                           | erminal Base Alloy J-STD-020 MSL |                     | L Rating  | Peak Process Body Temperature |                     | e Max Time at Peak                        | Tempera    | ture Numb                       | per of Reflow Cy                | cles             |      |           |  |
| contains Bi CU                            |   |                           | U Alloy 1                        |                     |   | <b>260</b> C                  |                     | 30  | seco       | nds 3                           |                                 |                  |      |           |  |
| Comments                                  |   |                           |                                  |                     |   |                               |                     |   |            |                                 |                                 |                  |      |           |  |
| level 1 - maximum t                       | ime at peak temperature d   | luring sol                | dering is 10-3                   | 0 seconds           |   |                               |                     |   |            |                                 |                                 |                  |      |           |  |
| For more informati                        | on regarding material com   | position <b>j</b>         | please refer to                  | page 3              |   |                               |                     |   |            |                                 |                                 |                  |      |           |  |

| RoHS Material Composition Declaration  |  |  |   | Declaration Type *  | Detailed  |  |  |  |  |  |  |  |
|--|--|--|---|---|---|--|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | (Pb), Mercury (Hg), Hexavalent Chro  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP). |   |   |   |  |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybromina<br>contains a RoHS restricted substance inexces<br>encompass all such components. Supplier cer<br>as of the date that Supplier completes this for<br>Company acknowledges that Supplier may h<br>independently verified information provided<br>certification in this paragraph. If the Company | ated biphenyls and/or polybrominated dip<br>s of an applicable quantity limit, please in<br>iffies that it gathered the information it pr<br>m.Supplier acknowledges that Company<br>ave relied on informationprovided by oth<br>by others, Supplier agrees that, at a minir<br>and the Supplier enter into a written agr<br>esource of the Supplier's liability and the | henyl ethers (each a "RoHS restricted substa<br>ndicate below which, if any, RoHS exemption<br>ovides in this form using appropriate methoo<br>will rely on this certification in determining<br>ers in completing this form, and that Supplie<br>num, itssuppliers have provided certification<br>eement with respect to the identified part, the<br>Company's remedies for issues that arise reg                               | nce") in exco<br>n you believe<br>ls to ensure i<br>the compliar<br>r may not ha<br>s regarding t<br>terms and co | e may apply. If the part is an assembly with low<br>s accuracy and that such information is true an<br>ce of its products with European Union member<br>de independently verified such information. Ho<br>neir contributions to the part, and those certifica | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>d correct to the best of its knowledge and belief,<br>er state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>ations are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |  |  |
| RoHS Declaration * 4 - Item(   | s) does not contain RoHS restricted subst  | ances per the definition above except for sele   | ected exempt  | ions Supplier Acceptance  | * Accepted  |  |  |  |  |  |  |  |
| Exemption: 7a: Lead in high melting temp   | erature type solders (i.e. lead based sol  | der alloys containing 85% by weight or m   | ore lead).  |   |   |  |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU   |  |   |   |   |  |  |  |  |  |  |  |
| Declaration Signature  |  |  |   |   |   |  |  |  |  |  |  |  |
| Instructions: Complete all of the required<br>Requester) and click on Submit Form to h   |  |  | e drop-dowi   | a. This will display the signature area. Digita   | lly sign the declaration (if required by the  |  |  |  |  |  |  |  |
| Supplier Digital Signature   | astislav Drska   | Le   |   |   |   |  |  |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Homogeneous Material | Weight | Unit of Measure | Level    | Substance           | CAS              | Exempt | Weight | Unit of Measure |
|----------------------|--------|-----------------|----------|---------------------|------------------|--------|--------|-----------------|
| Die                  | 0.51   | mg              | Supplier | Silicon (Si)        | 7440-21-3        |        | 0.51   | mg              |
| Die Attach Solder    | 0.24   | mg              | Supplier | Silver (Ag)         | 7440-22-4        |        | 0.006  | mg              |
|                      |        |                 | А        | Lead (Pb)           | 7439-92-1        | 7a     | 0.222  | mg              |
|                      |        |                 | Supplier | Tin (Sn)            | 7440-31-5        |        | 0.012  | mg              |
| Lead Frame           | 7.46   | mg              | Supplier | Silver (Ag)         | 7440-22-4        |        | 0.0642 | mg              |
|                      |        |                 | Supplier | Zinc (Zn)           | 7440-66-6        |        | 0.0142 | mg              |
|                      |        |                 | Supplier | Iron (Fe)           | 7439-89-6        |        | 0.1917 | mg              |
|                      |        |                 | Supplier | Copper (Cu)         | 7440-50-8        |        | 7.1795 | mg              |
|                      |        |                 | Supplier | Phosphorus (P)      | 7723-14-0        |        | 0.0104 | mg              |
| Mold Compound        | 6.47   | mg              |          | Epoxy resin         | proprietary data |        | 0.3235 | mg              |
|                      |        |                 | Supplier | Hardener            | Proprietary Data |        | 0.4529 | mg              |
|                      |        |                 | Supplier | Metal Hydroxide     | Proprietary Data |        | 0.3235 | mg              |
|                      |        |                 | Supplier | Carbon Black (C)    | 1333-86-4        |        | 0.0323 | mg              |
|                      |        |                 | Supplier | Fused Silica (SiO2) | 60676-86-0       |        | 5.3377 | mg              |
| Plating              | 0.43   | mg              | В        | Bismuth (Bi)        | 7440-69-9        |        | 0.0026 | mg              |
|                      |        |                 | Supplier | Tin (Sn)            | 7440-31-5        |        | 0.4274 | mg              |
| Wire Bond - Cu       | 0.07   | mg              | Supplier | Copper (Cu)         | 7440-50-8        |        | 0.07   | mg              |

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).